- 2. Surface–mounted on FR4 board using the minimum recommended pad size. 3. This is the absolute maximum ratings. Parts are 100% tested at  $T_J$  = 25°C,  $V_{GS}$  = 20 V,  $I_L$  = 29 A,  $E_{AS}$  = 42 mJ.

### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit		
Junction-to-Case (Drain)	$R_{ heta JC}$	3.8			
Junction-to-Ambient - Steady State (Note 4)	$R_{\theta JA}$	48.6	°C ///		
Junction-to-Ambient - Steady State (Note 5)	$R_{ heta JA}$	161.7	°C/W		
Junction-to-Ambient - (t ≤ 10 s) (Note 4)	$R_{\theta JA}$	19			

- Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
   Surface-mounted on FR4 board using the minimum recommended pad size.

# **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		30			V
Drain-to-Source Breakdown Voltage (transient)	V <sub>(BR)DSSt</sub>	$V_{GS} = 0$ V, $I_{D(aval)} = 12.6$ A, $T_{case} = 25$ °C, $t_{transient} = 100$ ns		34			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /				12		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 \text{ V}, \qquad T_{J} = 25^{\circ}\text{C}$ $V_{DS} = 24 \text{ V}$				1.0	
		V <sub>DS</sub> = 24 V	T <sub>J</sub> = 125°C			10	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V				±100	nA
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D =$	= 250 μA	1.3		2.2	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				5.1		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 30 A		2.7	3.4	0
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 30 A		4.0	5.0	mΩ
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 1.5 V, I <sub>D</sub> = 15 A			68		S
Gate Resistance	$R_{G}$	T <sub>A</sub> = 25°C		0.3	1.0	2.0	Ω
CHARGES AND CAPACITANCES							
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 15 V			1972		
Output Capacitance	C <sub>OSS</sub>				1215		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				59		
Capacitance Ratio	C <sub>RSS</sub> /C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 15 V, f = 1 MHz			0.030		
Total Gate Charge	Q <sub>G(TOT)</sub>				14		
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V; I <sub>D</sub> = 30 A			3.3		
Gate-to-Source Charge	$Q_{GS}$				6.0		nC
Gate-to-Drain Charge	$Q_{GD}$				5.0		
Gate Plateau Voltage	$V_{GP}$				3.1		V
Total Gate Charge	Q <sub>G(TOT)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 15 V; I <sub>D</sub> = 30 A			30		nC
SWITCHING CHARACTERISTICS (Note 7)							
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = 4.5 V, $V_{DS}$ = 15 V, $I_{D}$ = 15 A, $R_{G}$ = 3.0 $\Omega$			11		
Rise Time	t <sub>r</sub>				32		ns
Turn-Off Delay Time	t <sub>d(OFF)</sub>				21		
Fall Time	t <sub>f</sub>				7.0	_	

# **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS (N	ote 7)						•
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 15 V, $I_{D}$ = 15 A, $R_{G}$ = 3.0 $\Omega$			8.0		- ns
Rise Time	t <sub>r</sub>				26		
Turn-Off Delay Time	t <sub>d(OFF)</sub>				26		
Fall Time	t <sub>f</sub>				5.0		
DRAIN-SOURCE DIODE CHARACT	ERISTICS						
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V,	$T_J = 25^{\circ}C$		0.77	1.1	V
		I <sub>S</sub> = 10 A	T <sub>J</sub> = 125°C		0.62		]
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS} = 0 \text{ V, } dI_{S}/dt = 100 \text{ A/}\mu\text{s,}$ $I_{S} = 30 \text{ A}$			40.2		
Charge Time	t <sub>a</sub>				20.3		ns
Discharge Time	t <sub>b</sub>				19.9		
Reverse Recovery Charge	Q <sub>RR</sub>				30.2		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. Pulse Test: pulse width  $\leq 300~\mu s$ , duty cycle  $\leq 2\%$ .

7. Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**

140

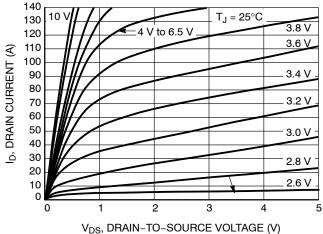
130

120

110

100

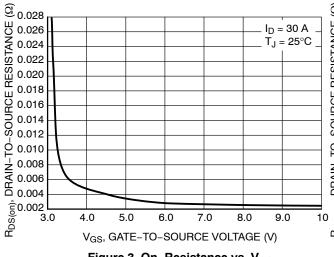
 $V_{DS} = 5 V$ 



ID, DRAIN CURRENT (A) 90 80 70 60 50 T<sub>J</sub> = 125°C 40 30 T<sub>J</sub> = 25°C 20 10 T<sub>J</sub> = -55°C 0 0.5 1.5 2.0 3.0 3.5

V<sub>GS</sub>, GATE-TO-SOURCE VOLTAGE (V) Figure 2. Transfer Characteristics





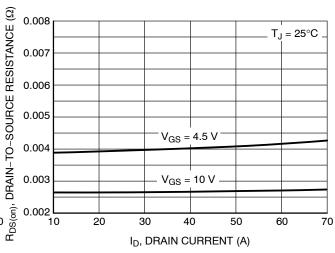
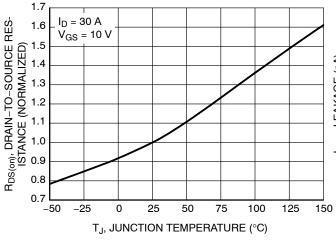


Figure 3. On-Resistance vs. V<sub>GS</sub>

Figure 4. On-Resistance vs. Drain Current and **Gate Voltage** 



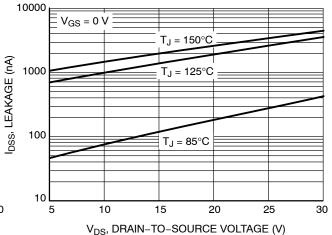


Figure 5. On-Resistance Variation with **Temperature** 

Figure 6. Drain-to-Source Leakage Current vs. Voltage

#### **TYPICAL CHARACTERISTICS**

V<sub>GS</sub>, GATE-TO-SOURCE VOLTAGE (V)

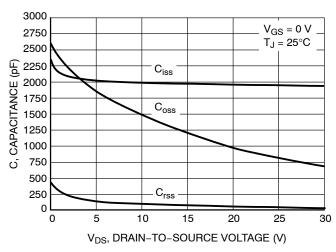


Figure 7. Capacitance Variation

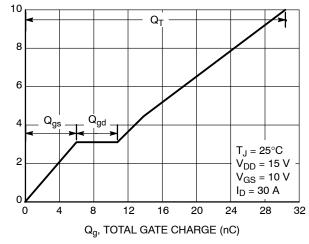


Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

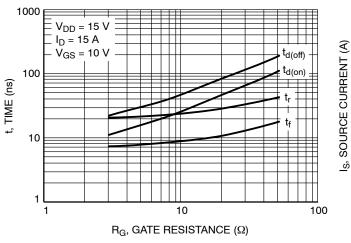


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

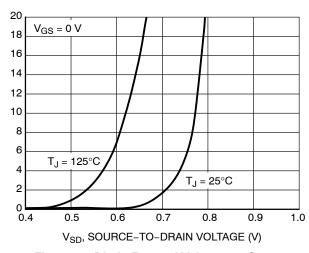


Figure 10. Diode Forward Voltage vs. Current

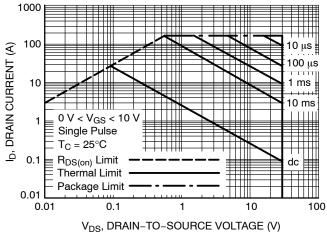


Figure 11. Maximum Rated Forward Biased Safe Operating Area

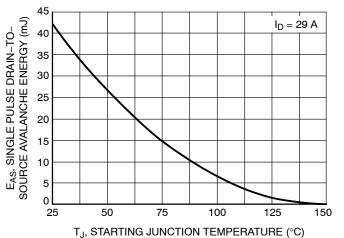


Figure 12. Maximum Avalanche Energy vs. Starting Junction Temperature

# **TYPICAL CHARACTERISTICS**

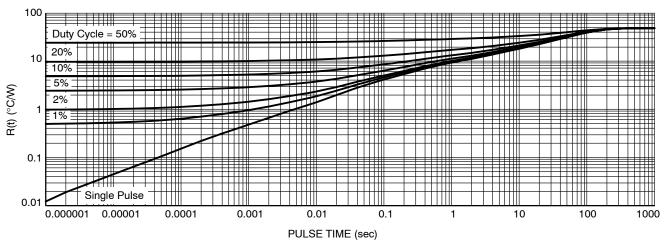


Figure 13. Thermal Response

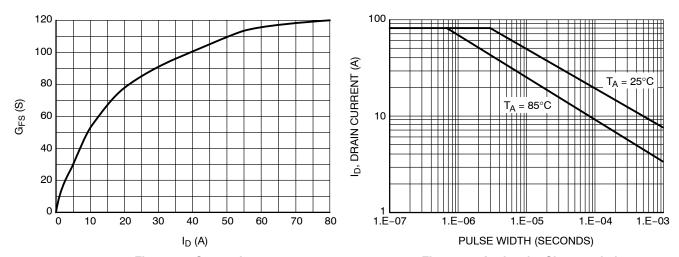


Figure 14. G<sub>FS</sub> vs. I<sub>D</sub>

Figure 15. Avalanche Characteristics



0.10

0.10 С

SIDE VIEW

DFN5 5x6, 1.27P (SO-8FL) CASE 488AA ISSUE N

**DATE 25 JUN 2018** 

#### NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
  CONTROLLING DIMENSION: MILLIMETER.
  DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS

	MILLIMETERS				
DIM	MIN	NOM	MAX		
Α	0.90	1.00	1.10		
A1	0.00		0.05		
b	0.33	0.41	0.51		
С	0.23	0.28	0.33		
D	5.00	5.15	5.30		
D1	4.70	4.90	5.10		
D2	3.80	4.00	4.20		
E	6.00	6.15	6.30		
E1	5.70	5.90	6.10		
E2	3.45	3.65	3.85		
е	1.27 BSC				
G	0.51	0.575	0.71		
K	1.20	1.35	1.50		
L	0.51	0.575	0.71		
L1	0.125 REF				
M	3.00	3.40	3.80		
A	n o		12 °		

#### **GENERIC MARKING DIAGRAM\***

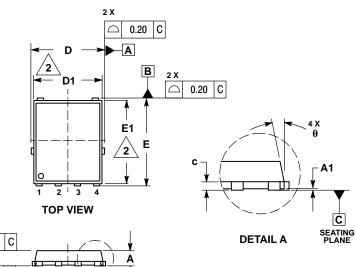


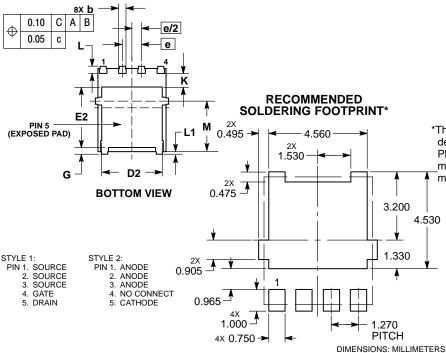
XXXXXX = Specific Device Code

= Assembly Location Α

Υ = Year W = Work Week ZZ = Lot Traceability

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.





**DETAIL A** 

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	DFN5 5x6, 1.27P (SO-8FL)		PAGE 1 OF 1	

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